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SUBMISSION TYPE:			NEW ASSIGNMENT				
NATURE OF CONVEYANCE:			ASSIGNMENT				
CONVEYING PARTY DATA							
		N	lame	Execution Date			
Hsiang Lan LUNG				12/31/2008			
Erh-Kun LAI				12/31/2008			
RECEIVING PARTY DATA							
Name:	Macronix Inte						
Street Address:	No. 16 Li-Hsin Road						
Internal Address:	Science-Based Industrial Park						
City:	Hsinchu						
State/Country:	TAIWAN	TAIWAN					
PROPERTY NUMBERS Total: 1							
Property Type			Number				
Application Number: 1234		12349	903				
Application Number: 12349903 CORRESPONDENCE DATA							
Fax Number: (650)712-0263							
Fax Number:(650)712-0263OCorrespondence will be sent via US Mail when the fax attempt is unsuccessful.G							
Phone: 650-712-0340							
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Correspondent Name: Mark A. Haynes Address Line 1: P. O. BOX 366							
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Address Line 2: HALF MOON BAY, CALIFORNIA 94019							
ATTORNEY DOCKET NUMBER:			MXIC 1872-2				
NAME OF SUBMITTER:			Mark A. Haynes				
Total Attachments: 2 source=ASSIGNMENT#page1.tif source=ASSIGNMENT#page2.tif							
500747952 PATENT 500747952 REEL: 022070 FRAME: 0247							

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ASSIGNMENT

WHEREAS, the undersigned,

(1)	Hsiang-Lan Lung 龍翔瀾	(2)	Erh-Kun Lai 賴二堒
	1401 Hunters Run Dobbs Ferry, NY 10522		48 Town Green Drive Elmsford, NY 10523

hereinafter termed "Inventors", have invented certain new and useful improvements in

INTEGRATED CIRCUIT MEMORY WITH SINGLE CRYSTAL SILICON ON SILICIDE AND MANUFACTURING METHOD

and have filed a non-provisional application for a United States patent disclosing and identifying the above invention on 07 JAN 2009 as Application No. 12/349,903 OR are filing such an application herewith, and have executed an oath or declaration of inventorship for such non-provisional application on:

(1) the 31 day of 12, 2008; (2) the 31 th day of 12, 2008;

(hereinafter termed "applications"); and

WHEREAS, Macronix International Co., Ltd., a corporation of Taiwan, having a place of business at No. 16, Li-Hsin Road, Science-Based Industrial Park, Hsinchu, Taiwan (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said applications and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventors jointly or severally (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventors to have been received in full from said Assignee:

1. Said Inventors do hereby jointly and severally sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said applications and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any applications; and (d) in and to each and every reissue or extensions of any of said patents.

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Said Inventors hereby jointly and severally covenant and agree to cooperate with 2. said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, jointly and severally, the inventors' respective heirs, legal representatives and assigns.

4. Said Inventors hereby jointly and severally warrant and represent that said inventors have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventors have executed and delivered this instrument to said Assignee as of the date written below.

<u>lhim In Ing</u> HSIANG-LAN LUNG 龍翔瀾 Date: 12-31-2000 Date: 12-31-2008 Erh-Kun Lai

ERH-KUN LAI 賴二琨

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